N-Channel 30V, 4.3mΩ Typ. Power MOSFET

Description

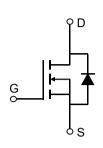
Features

• 30V, 60A

$$R_{DS(ON)}$$
 Typ = 4.3m Ω @ V_{GS} = 10 V

$$R_{DS(ON)}$$
 Typ = 6.5m Ω @ V_{GS} = 4.5V

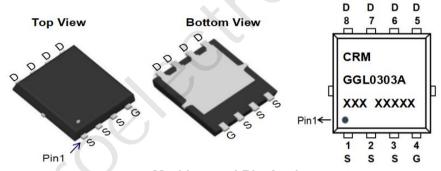
- Advanced Split Gate Trench Technology
- \bullet Excellent $R_{\text{DS}(\text{ON})}$ and Low Gate Charge
- 100% UIS TESTED!
- 100% ΔVds TESTED!





Application

- Load Switch
- PWM Application
- Power Management



Marking and Pin Assignment

Package Marking and Ordering Information

Device	Marking	Package	Outline	Reel Size	Reel (pcs)	Per Carton (pcs)
CRMGGL0303A	CRMGGL0303A	PDFN5x6-8L	TAPING	13"	5000	50000

Absolute Maximum Ratings (@ T_J = 25°C unless otherwise specified)

Symbol	Parameter		Value	Units
V_{DS}	Drain-to-Source Voltage		30	V
V_{GS}	Gate-to-Source Voltage	±20	V	
	Continuous Drain Current	T _C = 25°C	60	А
I _D	Continuous Drain Current	T _C = 100°C	36	Α
I _{DM}	Pulsed Drain Current (1)		240	Α
E _{AS}	Single Pulsed Avalanche Energy (2)		42	mJ
P_{D}	Power Dissipation	T _C = 25°C	34.7	W
$R_{ hetaJC}$	Thermal Resistance, Junction to Case		3.6	°C/W
T_J, T_STG	Junction & Storage Temperature Range		-55 to 150	°C

CRMGGL0303A

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Electrical Characteristics (T_J = 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Off Chara	acteristics					
V _{(BR)DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	30	-	-	V
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 30V, V_{GS} = 0V$	-	-	1.0	μА
I _{GSS}	Gate-Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA
On Chara	acteristics				6	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1.2	2	2.4	V
R _{DS(ON)}	Static Drain-Source ON-Resistance ⁽³⁾	V _{GS} = 10V, I _D = 12A	-	4.3	5.6	mΩ
		$V_{GS} = 4.5V, I_D = 8A$	-	6.5	8.5	mΩ
Dynamic	Characteristics					
C _{iss}	Input Capacitance		-(920	-	pF
C_{oss}	Output Capacitance	$V_{GS} = 0V, V_{DS} = 15V,$ f = 1MHz	X-\	793	-	pF
C_{rss}	Reverse Transfer Capacitance	1 - 11/11/2	- 1	47	-	pF
Q_g	Total Gate Charge		J -	16	-	nC
Q_gs	Gate Source Charge	$V_{GS} = 0 \text{ to } 10V$ $V_{DS} = 15V, I_{D} = 20A$	-	3	-	nC
\mathbf{Q}_{gd}	Gate Drain("Miller") Charge	VDS = 10 V, 10 = 20/1	-	3.3	-	nC
Switchin	g Characteristics					
$t_{d(on)}$	Turn-On DelayTime	.r ()	-	6.3	-	ns
t _r	Turn-On Rise Time	$V_{GS} = 10V, V_{DD} = 15V$	-	3.2	-	ns
$t_{\text{d(off)}}$	Turn-Off DelayTime	I_D = 20A, R_{GEN} = 3Ω	-	18	-	ns
$t_{\rm f}$	Turn-Off Fall Time		-	3.6	-	ns
Drain-So	urce Diode Characteristics and M	Max Ratings				
Is	Maximum Continuous Drain to Source Diode Forward Current			-	60	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	240	Α
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 8A$	-	-	1.2	V
trr	Body Diode Reverse Recovery Time	1 - 151 di/dt - 1001/:	-	27	-	ns
Qrr	Body Diode Reverse Recovery Charge	I _F = 15A, di/dt = 100A/us	-	11	-	nC

Notes:

^{1.} Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature.

^{2.} E_{AS} condition: Starting T_J =25°C, V_{DD} =30V, V_G =10V, R_G =25ohm, L=0.5mH, I_{AS} =13A

^{3.} Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%.

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Test Circuit

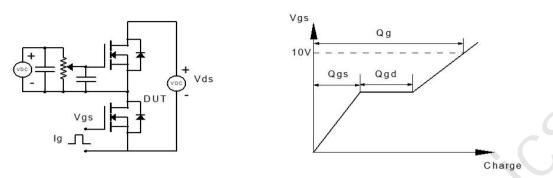


Figure 1: Gate Charge Test Circuit & Waveform

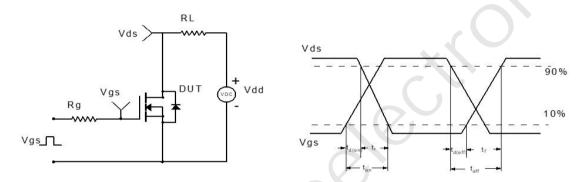


Figure 2: Resistive Switching Test Circuit & Waveform

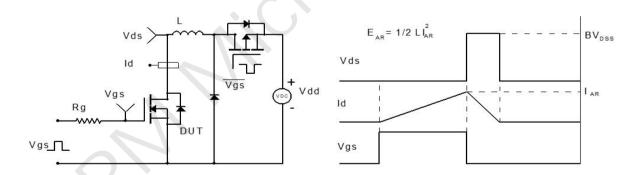


Figure 3: Unclamped Inductive Switching Test Circuit& Waveform

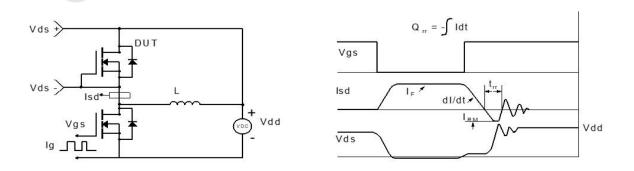
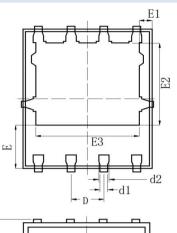


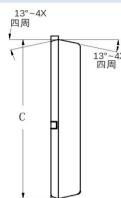
Figure 4: Diode Recovery Test Circuit & Waveform

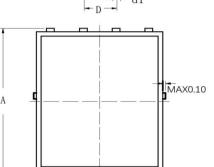
CRMGGL0303A

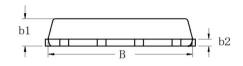
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Package Mechanical Data(PDFN5x6-8L)









COMMON DIMENSION (MM)					
PKG					
SYMBOL	MIN	TYP	MAX		
А	6.000	6.100	6.200		
В	4.875	4.900	4.925		
b1	0.975	1.000	1.025		
b2	0.246	0.254	0.262		
С	5.775	5.800	5.825		
D	1.245	1.270	1.295		
d1	0.275	0.300	0.325		
d2	0.375	0.400	0.425		
E	1.725	1.775	1.825		
E1	0.395	0.445	0.495		
E2	3.425	3.475	3.525		
E3	3.960	4.010	4.060		

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